



Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of “Quality Parts,Customers Priority,Honest Operation,and Considerate Service”,our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China



- **Steep Roll-off Filter for 915 MHz ISM band**
- **Complies with Directive 2002/95/EC (RoHS)**

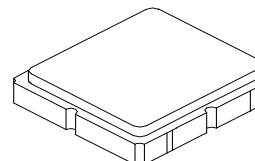


#### Absolute Maximum Ratings

Rating	Value	Units
Input Power Level	+24	dBm
DC Voltage on any Non-ground Terminal	5	V
Operating Temperature Range	-40 to +85	°C
Storage Temperature Range in Tape and Reel	-40 to +85	°C
Maximum Soldering Profile, 5 Cycles/10 seconds Maximum	265	°C

**SF2049E-1**

**915.00 MHz  
SAW Filter**



**SM3030-6**

#### Electrical Characteristics

Characteristic	Sym	Notes	Min	Typ	Max	Units
Center Frequency	$f_c$			915.00		MHz
Insertion Loss, 902 to 928 MHz	IL			2.2	3.5	dB
Peak-to-Peak Amplitude Ripple, 902 to 928 MHz				0.6	2.0	dB
VSWR, 902 to 928 MHz	SWR			1.6:1	2.3:1	
Attenuation, Referenced to 0 dB:						dB
DC to 800 MHz			50	63.0		
800 to 880 MHz			40.0	48.0		
960 to 1080 MHz			32.0	39.0		
1080 to 1500 MHz			45.0	65.0		
1500 to 3000 MHz			22.0	28.0		
Source Impedance	$Z_s$			50		$\Omega$
Load Impedance	$Z_L$			50		$\Omega$
Case Style	SM3030-6 3.0 x 3.0 mm Nominal Footprint					
Lid Symbolization (Y=year, WW=week, S=shift) dot=pin 1 indicator	917, YWWS					
Standard Reel Quantity	Reel Size 7 inch	500 Pieces/Reel				
	Reel Size 13 inch	3000 Pieces/Reel				

#### Electrical Connections

Connection	Terminals
Input	2
Output	5
Case Ground	All others

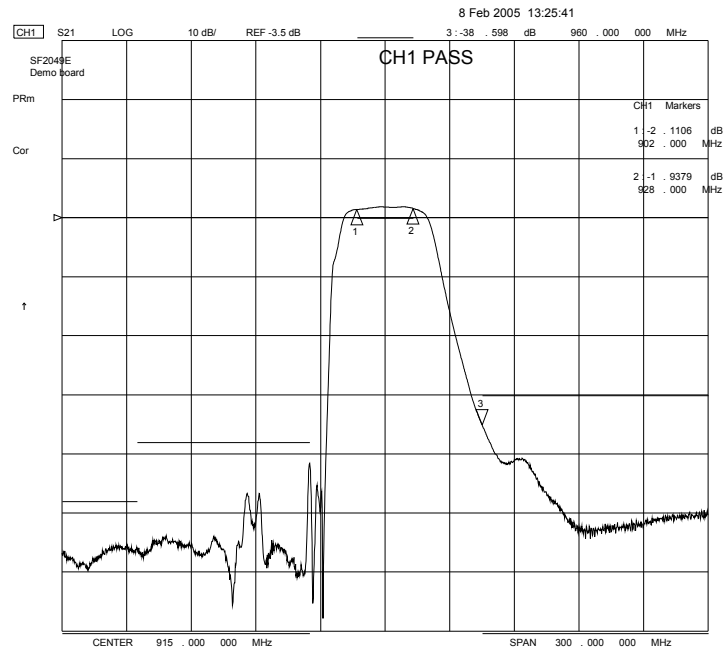


**CAUTION: Electrostatic Sensitive Device. Observe precautions for handling.**

#### NOTES:

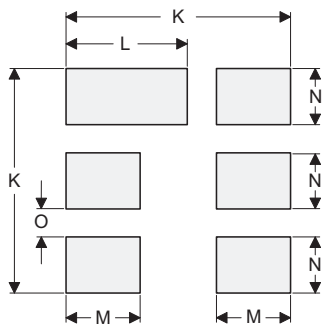
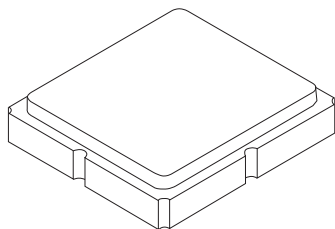
1. Unless noted otherwise, all specifications apply over the operating temperature range with filter soldered to the specified demonstration board with impedance matching to 50  $\Omega$  and measured with 50  $\Omega$  network analyzer.
2. Unless noted otherwise, all frequency specifications are referenced to the nominal center frequency,  $f_c$ .
3. Rejection is measured as attenuation below the minimum IL point in the passband. Rejection in final user application is dependent on PCB layout and external impedance matching design. See Application Note No. 42 for details.
4. "LRIP" or "L" after the part number indicates "low rate initial production" and "ENG" or "E" indicates "engineering prototypes."
5. The design, manufacturing process, and specifications of this filter are subject to change.
6. Either Port 1 or Port 2 may be used for either input or output in the design. However, impedances and impedance matching may vary between Port 1 and Port 2, so that the filter must always be installed in one direction per the circuit design.
7. US and international patents may apply.
8. Murata, stylized Murata logo, and Murata N.A., Inc. are registered trademarks of Murata Manufacturing Co., Ltd.

HBM ESD Test Result		MM ESD Test Result	
Applied Voltage (V)	Failure Quantity (pcs)	Applied Voltage (V)	Failure Quantity (pcs)
25	0	25	0
50	0	50	0
100	0	100	0
150	0	150	0
200	0	200	0



# SM3030-6 Case

## 6-Terminal Ceramic Surface-Mount Case 3.0 X 3.0 mm Nominal Footprint



PCB Footprint Top View

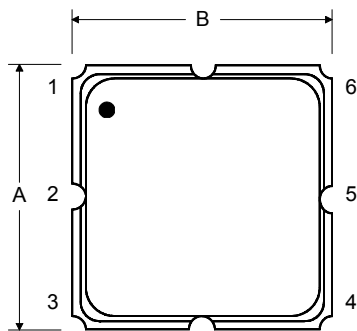
Case and PCB Footprint Dimensions

Dimension	mm			Inches		
	Min	Nom	Max	Min	Nom	Max
A	2.87	3.00	3.13	0.113	0.118	0.123
B	2.87	3.00	3.13	0.113	0.118	0.123
C	1.12	1.25	1.38	0.044	0.049	0.054
D	0.77	0.90	1.03	0.030	0.035	0.040
E	2.67	2.80	2.93	0.105	0.110	0.115
F	1.47	1.60	1.73	0.058	0.063	0.068
G	0.72	0.85	0.98	0.028	0.033	0.038
H	1.37	1.50	1.63	0.054	0.059	0.064
I	0.47	0.60	0.73	0.019	0.024	0.029
J	1.17	1.30	1.43	0.046	0.051	0.056
K		3.20			0.126	
L		1.70			0.067	
M		1.05			0.041	
N		0.81			0.032	
O		0.38			0.015	

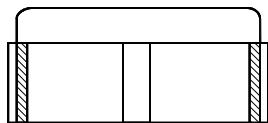
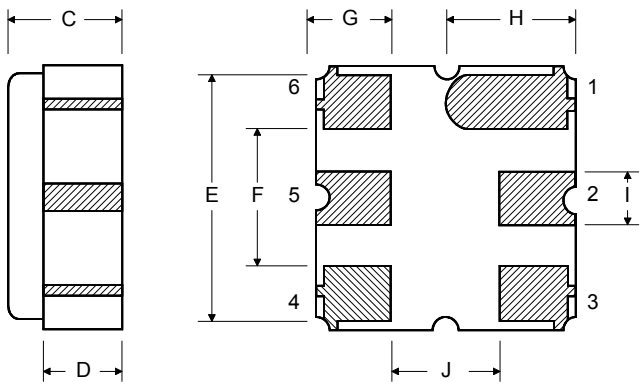
Case Materials

Materials	
Solder Pad Plating	0.3 to 1.0 $\mu$ m Gold over 1.27 to 8.89 $\mu$ m Nickel
Lid Plating	2.0 to 3.0 $\mu$ m Nickel
Body	Al <sub>2</sub> O <sub>3</sub> Ceramic
Pb Free	

TOP VIEW



BOTTOM VIEW





See Detail "A"

100 REF.  
"B" REF.

12.0

13.0  
20.2  
2.0

This technical drawing shows a top view of a circular part with a central hole. The part is centered on a horizontal and vertical dashed line. A leader line points from the central hole to a detail callout labeled "See Detail 'A'". To the right of the main view, a vertical dimension line indicates a distance of 100 REF. from the center to the top edge, and a dimension line labeled "B" REF. indicates the total height of the part. Below the main view, a detail view of the central hole is shown. This detail view is a cross-section of the hole, showing a circular shape with a central hole. The detail view has three dimensions: 13.0 (radius), 20.2 (outer diameter), and 2.0 (inner diameter). A horizontal dimension line below the detail view indicates a distance of 12.0 from the center of the main part to the center of the detail view.

“B”		Quantity Per Reel
Inches	millimeters	
7	178	500
13	330	3000

Carrier Tape Dimensions	
Ao	3.35 mm
Bo	3.35 mm
Ko	1.40 mm
Pitch	8.0 mm
W	12.0 mm

